

## 101342C

### FB72.825-1.74 72.825 MHz Bandpass Filter 1.74 MHz Bandwidth

### **Specifications**

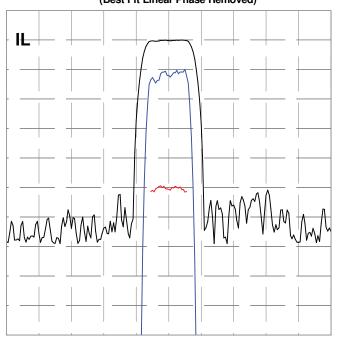
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	F <sub>0</sub>		72.825		MHz
Bandwidth	В		1.74		MHz
-3 dB Bandwidth	B <sub>3</sub>	1.9	2		MHz
-40 dB Bandwidth	B <sub>40</sub>		2.9	3	MHz
Delay	To	2.94	2.953	2.96	µsec
Insertion Loss	IL		20.4	21	dB
Amplitude Ripple			0.5	1	dB <sub>P-P</sub>
Phase Ripple			2.1	3	deg <sub>P-P</sub>
Rejection		46	50		dB
Spurious for $ t-T_0  > .9T_0$			-46	-44	dB
Substrate Material	38YX-Q				

#### **Notes**

- 1. Center Frequency  $(F_0)$  and Bandwidth (B) are defined, not measured.
- 2. Insertion Loss is the minimum loss for  $|f-F_0| < .5B$
- 3. Ripple spec applies to the  $|f F_0| < .4B$ , and is doubled for  $.4B < |f F_0| < .5B$
- 4. Rejection spec applies to  $(B_{40} \text{ Spec} B/2) < |f F_0| < F_0/2$
- 5. Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts  $dF_0 = -x * F_0$ ,  $dT_0 = x * T_0$ , where  $x = 3E-8 * (temperature 22 °C)^2$

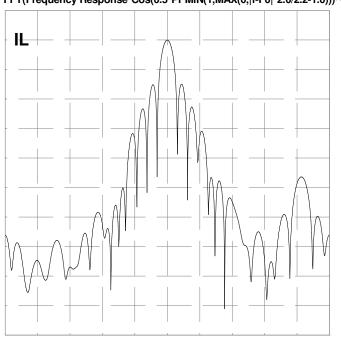
### **Typical Performance**

# Frequency Response (Best Fit Linear Phase Removed)



10 dB/div, 1 dB/div, 10 deg/div, 1.400 MHz/div

# Impulse Response FFT(Frequency Response\*Cos(0.5\*PI\*MIN(1,MAX(0,|f-F0|\*2.0/2.2-1.0)))^2)



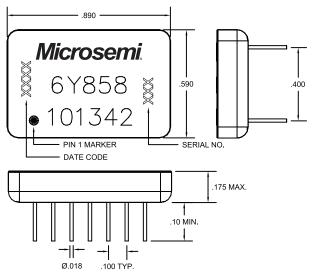
10 dB/div, 1.429 us/div



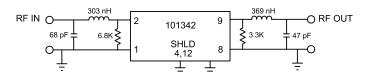
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### Package Outline



### Matching





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